Anodic oxidation of epitaxial superconductor-semiconductor hybrids


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We demonstrate a new fabrication process for hybrid semiconductor-superconductor heterostructures based on anodic oxidation (AO), allowing controlled thinning of epitaxial Al films. Structural and transport studies of oxidized epitaxial Al films grown on insulating GaAs substrates reveal spatial nonuniformity and enhanced critical temperature and magnetic fields. Oxidation of epitaxial Al on hybrid InAs heterostructures with a conducting two-dimensional electron gas (2DEG) show similarly enhanced superconducting properties transferred to the 2DEG by proximity effect, with critical perpendicular magnetic fields up to 3.5 T. An insulating AlO\textsubscript{x} film that passivates the heterostructure from exposure to air is obtained by complete oxidation of the Al. It simultaneously removes the need to strip Al which damages the underlying semiconductor. AO passivation yielded 2DEG mobilities two times higher than similar devices with Al removed by wet etching. An AO-passivated Hall bar showed quantum Hall features emerging at a transverse field of 2.5 T, below the critical transverse field of thinned films, eventually allowing transparent coupling of quantum Hall effect and superconductivity. AO thinning and passivation are compatible with standard lithographic techniques, giving lateral resolution below <50 nm. We demonstrate local patterning of AO by realizing a semiconductor-based Josephson junction operating up to 0.3 T perpendicular.

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I. INTRODUCTION

The recent emergence of epitaxial semiconductor-superconducting hybrid materials has provided numerous experimental systems with highly controllable electronic and superconducting properties [1–14]. Interest has been sparked by theoretical predictions of topological phases in one-dimensional (1D) superconductor-semiconductor hybrids [15,16] with possible application toward topological quantum computing [17]. Alternatively, topological phases can be achieved in 2D systems combining superconductivity with top-down fabricated narrow wires [18–20], Josephson junctions [21–23] or quantum Hall edges in fully 2D systems proximitized by superconductivity [24,25].

In each of these instances, the subgap density of states is a key property of the hybrid system [26,27]. Low subgap density of states, typically extracted from the subgap conductance in a tunneling measurement, is associated with high transparency of the semiconductor-superconductor interface, that is, high Andreev reflection probability [28,29]. Near-unity interface transmission probabilities have been achieved by in situ molecular beam growth of epitaxial Al-InAs hybrid heterostructures in different geometries: Vapor-liquid-solid nanowires [1,2], selective area grown nanowires [9,10], and shallow two-dimensional electron gases (2DEGs) [5,6,30]. Recently, similar high-interface transparency were reported for other hybrid nanowires such as Sn-InSb [12], Ta-InAs [13], and Pb-InAs [14].

Despite their high Andreev reflection probability and resulting hard induced gap, InAs-Al hybrid platforms face two important challenges: (i) surface scattering and reduced mobility resulting from the quantum well being close to the surface, and (ii) limited critical magnetic fields due to the use of Al. Regarding surface scattering, by design the semiconductor wave function must extend to the surface when Al is present. Once the Al is removed, carriers are susceptible...
to surface scattering, resulting in a drop in mobility [31]. Sensitivity to surface chemistry of shallow 2DEGs for similar materials was recently investigated in Ref. [32]. For hybrid heterostructures with Al, a significant contribution to surface scattering is added by the standard Al etching process [5]. Regarding low critical magnetic field, we note that magnetic fields are used in these materials for a variety of purposes, particularly to drive the topological transition [15,16,24,25]. The applied superconductor should have critical fields higher that the field needed to drive the transition. In typical applications of 1D hybrids, a magnetic field, $B_{\perp}$, along the axis of the 1D nanowire lowers states by Zeeman splitting into the superconducting gap, where, in the presence of spin-orbit coupling, a topological superconducting phase can appear. An intriguing application of 2D hybrids is to drive the system into the quantum Hall regime by applying a perpendicular magnetic field, $B_{\perp}$, creating edge states that coexist with superconductivity.

High critical fields are found in type-II superconductors such as MoRe, with $B_{c2} \sim 8$ T [4], and NbN with $B_{c2} \sim 25$ T [7]. These materials allow penetration of flux, creating vortices, that decrease Andreev reflection probability when used for proximity effect [7], potentially leading to unwanted subgap state. MoRe and NbN have been deposited ex situ on the edge of high mobility quantum-well heterostructures such as GaAs/AlGaAs [3] or Graphene/hBN [4,7], yielding superconducting features within the integer Quantum Hall regime. The studies show moderate Andreev reflection probability, possibly associated with ex situ deposition.

To date, superconductors showing high-transparency interfaces with semiconductors, including Al, Sn, Ta, and Pb, have been type I, with relatively low critical magnetic fields, $B_c < 100$ mT in bulk. However, as thin films these same materials show large in-plane critical field, $B_{c||}$, for instance $B_{c||} > 8.5$ T reported for a 15-nm-thick layer of Pb [14], and $B_{c||} > 3$ T for 5- to 7-nm Al films [19]. Though not coupled to a heterostructure, $B_{c||} > 9$ T was measured [33] on a 2-nm thin Al film and a perpendicular critical field $B_{c\perp} \sim 3.6$ T was extrapolated [34] from granular aluminum [35,36].

In this work, we develop a method to apply ex situ anodic oxidation (AO) to epitaxial Al, the top layer of a heterostructure stack grown by molecular beam epitaxy on III-V substrates. AO is demonstrated to thin the metallic Al, improving its material properties for these applications, and, when AO is applied with higher voltage, to fully oxidize the Al, it results in an insulating AlOx layer and a semiconductor interface that has never been exposed to air. In both applications, local patterning using electron beam lithography is employed.

The rest of the paper is organized as follows: Section II gives experimental details of the AO process. Section III presents structural analysis of anodized Al on insulating GaAs. Section IV presents transport properties of Al on insulating GaAs. Turning to InAs heterostructures with conducting quantum wells, Sec. V presents enhanced superconducting properties after thinning of Al by AO. Passivation of the 2DEG by complete oxidation of Al is presented in Sec. VI, followed by quantum Hall measurements on an AO-passivated Hall bar. Finally, in Sec. VII, a fabrication scheme is presented that provides high-resolution AO patterning.

FIG. 1. Hybrid heterostructures grown by molecular beam epitaxy, with Al films on III-V substrates. (a) Sample 1, Al on insulating GaAs (100) substrate. (b) Sample 2, Al capping a shallow InAs heterostructure supporting a two dimensional electron gas. (c) Micrograph of an Al-InAs Hall bar (device α) characterized by four different regions oxidized with different AO voltages, $V_{AO}$. (e)–(h) Regimes of anodic oxidation for $V_{AO}$ between 3.5 V and 5.5 V. Increasing $V_{AO}$ increases oxidation depth, until only alumina is left, as indicated. (b) Further increasing $V_{AO}$ oxidizes the underlying III-V.

II. FABRICATION AND MEASUREMENT

Two heterostructures, denoted samples 1 and 2, were grown by molecular beam epitaxy. Sample 1 consisted of a 7-nm epitaxial Al layer grown on an insulating GaAs substrate, see Fig. 1(a). This sample allowed study of the AI film as the only conductor. Sample 2 consists of an 8-nm epitaxial Al layer grown on a shallow InAs heterostructure, see Fig. 1(b). Sample 2 allows the effects of AO on Al coupled to an InAs quantum-well 2DEG to be investigated, including superconducting proximity effect for thin Al, and surface passivation for fully oxidized Al.

The AO technique we employ is widely used in industry [37,38]. Under atmospheric conditions, Al forms a native oxide saturating at ~3 nm [39]. AO enables a deeper oxidation, with a depth controlled by an applied voltage $V_{AO}$. Figure 1(c) sketches the AO setup: $V_{AO}$ is applied between the Al and an electrolyte solution in which the substrate is submerged. The voltage drives ions to the Al-AlOx surface, increasing the oxidation depth. Depending on the electrolyte used, two oxide morphologies can form [38]. The one of interest is thin and uniform, with $V_{AO}$ controlling the oxidation depth. This oxide type, described in Refs. [38,40], can be achieved by implementing tartaric acid, 3% by mass, as electrolyte, regulated to pH ~ 5.5 by ammonium hydroxide. A voltage-dependent oxide thickness of 1.3 nm/V is expected. Further details of the setup are given in Sec. A of supplemental material (SM) [41]. Standard electron beam lithography was used to pattern elongated Hall bars from an InAs 2DEG heterostructure, shown in Fig. 1(d) and from Al on GaAs, in SM Sec. B [41].

On sample 1 [Fig. 1(a)], AO was patterned into areas with $V_{AO} = 4$ V. Two areas on the sample, designated AO$_T$ and AO$_H$, were exposed simultaneously to check for consistency. A subsequent wet etch defined elongated Hall bars in both anodized and unprocessed epitaxial Al.
On sample 2 [Fig. 1(b)], grown on an InP substrate, a standard III-V wet mesa etch defined Hall bars and bonding pads for ohmic contacts. In four sequential lithography steps, AO was performed at voltages $V_{AO} = 3.5, 4.2, 4.8, \text{ and } 5.5 \text{ V }$ on different areas, as shown in Fig. 1(d). Following AO, an 18-nm HfO layer was deposited globally by atomic layer deposition, followed by deposition of patterned Ti-Au gates. Two Hall bars, denoted $\alpha$ and $\beta$, each with four AO exposures, were fabricated simultaneously on the same chip, again to check consistency. Figure 1(d) shows Hall bar $\alpha$. Further InAs fabrication details are given in SM Sec. C [41]. These voltages yielded outcomes of two types: For smaller $V_{AO}$, the thickness of Al was reduced and its morphology altered, but it remained a metallic conductor. For larger $V_{AO}$, complete oxidation occurred, as illustrated in Fig. 1(g). Increasing $V_{AO}$ further began to oxidize the semiconductor, leading to increased disorder, as indicated in Fig. 1(h).

Measurements were carried out in various dilution refrigerators, each with a base temperature $\sim 20 \text{ mK}$ and a 6-1,1-T vector magnet. Standard ac lock-in techniques were used to apply a small ac current $I$ in the range 1–10 nA while measuring the longitudinal voltage, $V_{xx}$. Longitudinal resistivity $\rho_{xx}$ was obtained from the measured differential resistance, $dV_{xx}/dI$, by division with 5.0, the ratio of voltage-probe separation to Hall bar width.

### III. ANODIZED Al ON INSULATING GaAs: STRUCTURAL ANALYSIS

To check the uniformity of Al films following AO, sample 1 was characterized with scanning transmission electron microscopy (STEM) and electron energy loss spectroscopy (EELS). STEM sample was prepared (Thermo Fisher dual beam SEM/FIB Helios 4G) with accelerating voltage 500 V for final thinning of the focused ion beam (FIB) lamella. STEM imaging (Thermo Fisher aberration-corrected Themis Z) used an accelerating voltage of 300 kV, giving a resolution of 65 pm. STEM images were acquired along the [110] zone axis in the semiconductor. EELS data acquisition was performed in STEM mode at 300 kV with an energy resolution of 0.75 eV and a dispersion of 0.05 eV.

Figure 2(a) shows a high-angle annular dark-field (HAADF) micrograph of AO$_3$ at the GaAs-Al interface. Three Al hills (dark gray) are distinguishable from GaAs (bright) and AlO$_x$ (black). Hills of Al, $\sim 2 \text{ nm }$ in height, were observed across the entire cross section. Fast Fourier transform of the hills extracts a crystal growth direction along [110], see SM Sec. D [41]. The origin of the Al hills is not known. Possible explanations include roughness after growth, increased oxidation at grain boundaries or degradation of the lamella during FIB preparation.

EELS was implemented to analyze the elemental configuration [42,43]. Specifically, a study was done to conclude whether the region in between Al hills had metallic Al or only alumina. High resolution STEM micrographs in HAADF mode were acquired at the Al-GaAs interface between Al hills, one is shown in Fig. 2(b). EELS analysis was done at points on a line along the growth direction, see Figs. 2(b) and 2(c). Dual EELS mode was used, allowing simultaneous acquisition of the Al L-edge ($\sim 80 \text{ eV}$) and O K-edge ($\sim 540 \text{ eV}$). All EELS data had a background subtracted, was then normalized and averaged over 20 points.

When GaAs is imaged, a shoulder around 110 eV [marked by $\triangle$ in Fig. 2(c)] is expected. Metallic aluminum has one peak around 97 eV ($\star$) while alumina has two peaks around 79 eV ($\circ$) and 98 eV ($\ast$). Oxygen produces a peak around 540 eV ($\square$). At the Al L-edge, GaAs ($\triangle$) is evident at points 6 and possibly 5; alumina ($\circ$) is evident at points 1 to 3, possibly 4; metallic Al ($\star$, no $\circ$) is evident at points 4 and 5. Inspecting the O K-edge, oxygen ($\square$) is only present in points 1–3, indicating that point 4 is metallic Al.

To obtain statistics on the global morphology of the Al after AO, nine additional EELS analyses were conducted in between other Al hills. One region out of 10 failed to show metallic Al, suggesting that roughly 10% of regions between hills are fully oxidized. A collection of broad-view STEM [Fig. 2(a)] were used to extract the fraction of hills to off-hill regions across the film. Hills have an average height of 2 nm and cover roughly one third of the imaged regions. Within the remaining two thirds, $\sim 10\%$ appears fully oxidized. The remaining $2/3 \times 9/10 = 3/5$ contains a thin metallic Al layer. Measurements of the metallic Al thickness between hills span 3 to $6 \text{ Å}$ ($5 \text{ Å }$ on average), corresponding to roughly one to two monolayers (ML) of Al. Additional scans are shown in SM Sec. D [41]. In summary, an uneven, though continuous, Al film is formed by AO.

### IV. ANODIZED Al ON INSULATING GaAs: TRANSPORT STUDIES

We investigate the effect of AO on the superconducting properties of the thinned Al films. Critical in-plane magnetic
Zeeman splitting could originate from the high surface-to-volume ratio of the anodized films, which could lead to large Rashba spin-orbit coupling within the film [48].

Critical perpendicular magnetic field as a function of temperature \( B_{c,\perp}(T) \), is displayed in Figs. 3(b) and 3(c). We determine \( B_{c,\perp} \) as the field for which \( \rho_N(B_{c,\perp}) = 0.01 \rho_N \). A base-temperature scan of the AG sample yielded \( B_{c,\perp} = 32 \text{ mT} \), higher than the bulk Al value \( B_c \sim 10 \text{ mT} \) [49]. Scans used to determine \( B_{c,\perp}(T) \) for \( \text{AO}_1 \) are shown in Fig. 3(b). Extracted critical fields for \( \text{AO}_1 \) and \( \text{AO}_{II} \) are shown in Fig. 3(c) \( \text{AO}_{II} \) scans are shown in SM Sec. E [41]). A nearly two orders of magnitude increase in \( B_{c,\perp} \) at 2.5 T is observed. This is comparable with \( B_{c,\perp} \) extrapolated from measurements on granular aluminum [34,35].

Just below 3 T, a crossover point for different isotherms is observed. Such crossovers indicate superconductor-insulator transitions, studied in thin and/or disordered superconductors [50–54]. A similar crossing was not observed in the probed range of \( B_1(T) \), but it might occur beyond 6 T. The resistance jumps seen below 1 T at high temperatures track temperature fluctuations, which were monitored simultaneously.

Comparing \( B_{c,\parallel}(T) \) and \( B_{c,\perp}(T) \), the latter has a more linear \( T \) dependence. This is expected from Ginzburg-Landau theory and previously observed in thin quenched-condensed Al films [55]. Another feature worth highlighting is the upward curvature of \( B_{c,\perp}(T) \) for \( T \lesssim T_c \), previously observed in thin granular aluminum [56], where the authors attributed the effect to electron localization and electron-electron interaction.

V. ANODIZED Al on InAs 2DEG: TRANSPORT STUDIES

Transport measurements of sample 2, comprising \( \text{AO} \) of epitaxial Al on a heterostructure with a shallow InAs 2DEG, show similar trends in field and temperature as Al on insulating GaAs with the addition of transport signatures from the 2DEG at \( B_\perp > B_{c,\perp} \). Figure 4(a) shows \( B_{c,\parallel}(T) \) for Hall bars from device \( \alpha \) and \( \beta \), anodized at \( V_{\text{AO}} = 3.5 \text{ V} \) and 4.2 V respectively, as well as a Hall bar with as-grown aluminum, \( \text{AG}_2 \), the subscript indicating sample 2. The data are extracted from \( \rho_{xx}(B_{\parallel}) \) scans at fixed temperature. Lower-left inset displays \( \rho_{xx}(B_{\parallel}) \) from \( \text{AG}_2 \) and 3.5 V Hall bars measured at 20 mK, showing a sharp superconducting transition. Top-right inset presents 4.2 V measurements of \( \rho_{xx}(B_{\parallel}) \) at 1.8 K, showing broad superconducting transitions. The full set of measurements are included in SM Sec. F [41].

\( \text{AG}_2 \) has a normal state resistivity \( \rho_{N,\text{AG}_2} = 6 \Omega/\square \). On both \( \alpha \) and \( \beta \), the Al anodized with 3.5 V has \( \rho_{N,\text{AG},3.5,\alpha} = 0.01 \rho_N \). Temperature sweeps were also used to extract \( T_c(B_{\parallel} = 0) \). AG has \( T_c = 1.6 \text{ K} \) while \( \text{AO}_1 \) has \( T_c = 2.3 \text{ K} \).

For a BSC-like superconductor with \( T_c = 2.3 \text{ K} \), the theoretical Chandrasekhar-Clogston (CC) limit [45,46] for the critical field, assuming a metallic Lande \( g \) factor of 2, is \( B_c(T = 0) \sim 4.6 \text{ T} \), which is clearly violated in these samples. Violation of CC limit has earlier been reported on a Pb film [47], where the authors claim that the spins are momentum locked in Rashba subbands due to high spin-orbit energy, which suppresses Zeeman splitting. A related suppression of Zeeman splitting could originate from the high surface-to-volume ratio of the anodized films, which could lead to large Rashba spin-orbit coupling within the film [48].
FIG. 4. Transport data from sample 2. (a) Critical in-plane field, $B_{\perp}(T)$, as a function of temperature, $T$, for as grown Al, AG₂, and $V_{AO} = 3.5$ and $4.2$ V Hall bars on devices $\alpha$ and $\beta$. Some of the 3.5 and 4.2 V points were measured twice. Examples of $\rho_{xx}(B_{\perp})$ scans are included in the insets, taken at the stated temperatures. (b) $\rho_{xx}$ as a function of $B_{\perp}$ at different temperatures for the anodized Al film at 4.2 V. Inset: Heterostructure of sample 2. (c) Extraction of $T_{c}$ for both Hall bars anodized at 3.5 V and for AG₂, extracted from scans displayed in the inset.

Both of the sample-2 AO Hall bars using $V_{AO} = 4.2$ V have resistivities an order of magnitude lower than the resistivity of AO₂ on GaAs, due to parallel conduction through the 2DEG. The fact that $\rho_{N,4.2,\beta} > \rho_{N,4.2,\alpha}$ indicate that the Hall bar $\beta$ has a thinner or more disordered Al film. It also has a lower $T_c$ indicating that we are beyond the optimal thickness or disorder for $T_c$ after which it is expected to drop [35,57]. The notable difference between the two 4.2 V Hall bars indicates a lack of repeatability. For these few-ML-thick aluminium films a small change in thickness or disorder have a large impact on the transport, making these films good probes for repeatability. The devices were made simultaneously from the same fabrication steps. Discrepancies could arise from sensitivity to the time over which AO was carried out, or due initial fabrication steps. Discrepancies could arise from sensitivity to the time over which AO was carried out, or due initial inhomogeneity in the Al thickness, even in the ML range.

Figure 4(b) shows $\rho_{xx}(B_{\perp})$ scans at different temperatures of the $V_{AO} = 4.2$ V, $\beta$ device, while data from $V_{AO} = 4.2$ V, $\alpha$ is shown in SM Sec. F [41]. In both cases we again see a crossing of the isotherms, but on the GaAs substrate, Fig. 3(b), $\rho_{xx}(B_{\perp})$ converges shortly after the crossing. On InAs, at least up to 6 T, $\rho_{xx}(B_{\perp})$ keeps changing, possibly due to $B_{\perp}$-induced orbital effects in the 2DEG, which we investigate in Ref. [58].

Even though the normal state resistances increase in $B_{\perp}$, to extract $B_{\perp}(T)$, we use 1% of the same $\rho_N$ that was used when extracting $B_{\perp}(T)$. The result is displayed on Fig. 4(c) together with extractions from the other four Hall bars. Both of the 3.5 V and the AG₂ Hall bar were only measured at base temperature, line scans shown in the inset. $B_{\perp}(T \sim 20 \text{ mK}) = 40 \text{ mT}$ for AG₂ Hall bar, 230 mT for the 3.5 V Hall bars, while 4.2 V $\alpha$ and $\beta$ has $B_{\perp} = 3.0$ T and 3.5 T, respectively. As observed for anodized Al on GaAs substrate, Fig. 3(c), these films resemble granular Al, with $B_{\perp}$ increased by more than two orders of magnitude and with the $B_{\perp}(T)$ dependence being close to linear with an upward curvature close to $T_c$.

VI. PASSIVATION OF SHALLOW InAs 2DEG

Further increase of $V_{AO}$ resulted in Hall bars having finite resistance at base temperature, indicating a full oxidation of the Al film. Such an outcome allows the semiconductor underneath to be passivated and 2DEG density to be controlled with the top-gate. Top gating was found to be possible on Hall bars anodized at $V = 4.8$ V and 5.5 V, see Figs. 5(a) and 5(b), indicating that the residual metallic Al film was either discontinuous or completely oxidized.

Characterization of the two Hall bars was done measuring longitudinal resistivity $\rho_{xx}$ and Hall resistivity $\rho_{xy} = dV_{xy}/dI$ as a function of $B_{\perp}$ and top-gate voltage, $V_{TG}$, to extract carrier density, $n_c$, and carrier mobility, $\mu$, from the low field Hall effect. The same analysis has been performed on a Hall bar fabricated with standard chemical wet etch of the Al film. The $V_{TG}$ dependence of mobility, $\mu$, versus density, $n_c$ for the three Hall bars is shown in Fig. 5. Details concerning the fabrication of the etched Hall bar and additional quantum Hall data of another Hall bar, also anodized at 4.8 V, are given in SM Sec. G [41].

Carrier density as a function of $V_{TG}$ is shown in Fig. 5(a). For all Hall bars, $n_c$ decreased monotonically with negative gate voltage $V_{TG}$ (the etched Hall bar was noisy for $V_{TG} > -0.3$ V). At $V_{TG} = 0$, the etched Hall bar has $n_c \sim 4 \times 10^{10}$ m⁻², while the Hall bars anodized at 5.5 V and 4.8 V has $n_c = 1.1 \times 10^{16}$ m⁻² and $n_c = 9.8 \times 10^{15}$ m⁻², respectively. The same order is observed in the slope of $n_c$ versus $V_{TG}$, with the etched Hall bar having the steepest slope and the 4.8 V Hall bar slope being most flat. Corresponding mobilities are shown in Fig. 5(b) as a function of $V_{TG}$ and in Fig. 5(c) as...
function of $n_e$. We speculate on the origin of the nonmonotonic dependence of mobility with density: At low densities, the initial increase in $\mu$ with increasing $n_e$ presumably reflects an increased range of validity for Thomas-Fermi screening. A peak in mobility followed by a decrease with further increase of $n_e$ presumably reflects a greater concentration of electrons at the surface.

The wet-etched Hall bar has a mobility peak of $4.2 \, \text{m}^2/\text{Vs}$ at $n_e = 6.1 \times 10^{15} \, \text{m}^{-2}$, which is high for a shallow 2DEG structure, taking into account that this 2DEG has transparent coupling to the Al, as shown in Ref. [23]. The Hall bar anodized at 4.8 V has an increased mobility peak of $8.0 \, \text{m}^2/\text{Vs}$ at $n_e = 7.7 \times 10^{15} \, \text{m}^{-2}$ while the 5.5 V AO Hall bar has a reduced mobility peak of $3.7 \, \text{m}^2/\text{Vs}$ at $n_e = 6.5 \times 10^{15} \, \text{m}^{-2}$. It is known that the aluminum etch damages the underlying semiconductor [5], partially due to the exposure to atmosphere [32]. We attribute the increased peak mobility after 4.8 V AO to an alumina passivation of the III-V, as depicted in Fig. 1(g), decreasing surface scattering compared to the etched Hall bar. AO at 5.5 V showed decreased peak mobility compared to the etched Hall bar. We suspect that such a voltage introduces disorder by contributing to oxidation of the semiconductor underneath, as depicted in Fig. 1(g).

Measurements of $\rho_{xx}$ and $\rho_{xy}$ as a function of $V_{TG}$ and $B_{\perp}$ up to 6 T are shown in Fig. 6. These data are for the highest mobility Hall bar, anodized at 4.8 V. Figure 6(a) shows $\rho_{xx}$ as a function of $B_{\perp}$ for different $V_{TG}$ between 0 and $-2.5 \, \text{V}$. Exponential increase of the zero-field $\rho_{xx}$ when biasing $V_{TG}$ negatively suggests good gateability through the anodized Al. Shubnikov de Haas oscillations (SdHO) are visible for $B_{\perp} > 1 \, \text{T}$ with vanishing minima of $\rho_{xx}$ for $B_{\perp} \sim 2.5 \, \text{T}$. We emphasize that this value of field is $\sim 1 \, \text{T}$ lower than our highest superconducting $B_{c\perp}$. Along with vanishing $\rho_{xx}$, quantized plateaus of $\rho_{xy}$ are observed in Figure 6(b) for $\rho_{xy}$ with $B_{\perp} > 2 \, \text{T}$, indicating that the sample is within the quantum Hall regime at fields below $B_{c\perp}$.

Besides SdHO, extra $\rho_{xx}$ peaks are present in Fig. 6(a). Starting at the least negative $V_{TG}$, a broad and high resistivity spike is observed between 4 and 6 T and a smaller increment to $\rho_{xx}$ is observed just below 2 T. For the most negative $V_{TG}$, the high field spike moves towards 3 T, and the increment below 2 T becomes more prominent. Lastly a weak localization peak [59] is observed around $B_{\perp} = 0$.

Additional features are observed in the Hall resistivity as well. At fields where $\rho_{xx}$ has additional spikes, $\rho_{xy}$ is noisy and forms noninteger plateaus. Below 4 T, $\rho_{xy}$ only has plateaus at odd fractions. This is seen more clearly in Fig. 6(c), displaying a color map of $\rho_{xy}(V_{TG},B_{\perp})$, from which we extract the filling factor $\nu$ and display it across the map. The same $\nu$ are added to a color map of $\rho_{xx}(V_{TG},B_{\perp})$, Fig. 6(d), showing a Landau fan diagram with additional features. The most obvious of these, a resonance crossing the fan at high fields, marked by red arrows, is the origin of the high field resistance spikes mentioned above. We notice that above the resonance, $\nu$ has regular even integer counting with spin-splitting into odd values around $B_{\perp} \sim 5 \, \text{T}$. Below the resonance, $\nu$ obtains odd integer counting. Another, less prominent, resonance, marked by the blue arrow, is the origin of the increment and spikes below 2 T in Fig. 6(a). A better visualization of the low-field features is obtained from an un-saturated color map of $\rho_{xx}(V_{TG},B_{\perp})$ included in SM Sec. H [41].

Similar high field studies, presented in SM Sec. H [41], were done on two other Hall bars; the other bar anodized at 4.8 V and an etched Hall bar. Both studies display similar additional $\rho_{xx}$ resonances. In all cases, the resonances have a weaker $V_{TG}$ dependence than the respective 2DEG Landau fans, suggesting the presence of an additional subband residing in the heterostructure below the InAs 2DEG.
FIG. 7. (a) Schematic illustration of the fabrication process combining standard lithography techniques with metal masks and anodic oxidation. (b) False-color scanning electron micrograph of the reported narrow Josephson junction. The remaining thin Al layer is in red, and the gates are represented in yellow. The two side gates $V_W$ are kept at $-1.6$ V for the experiments. Transport was current-biased with voltage drop, $V$, measured in a four-terminal configuration. Field directions $B_\perp$ and $B_z$ are defined in the bottom left part of the figure. (c) Saturated color map of the differential resistance $dV/dI$ as a function of current bias $I_{dc}$ and top-gate voltage $V_{TG}$. (d) Saturated color map of $dV/dI$ as a function of current bias and perpendicular field for $V_{TG} = 0$. (e) Extended color map of $dI/dV$ as a function of $I_{dc}$ and $B_\perp$ showing supercurrent oscillations surviving high fields $B_\perp > 300$ mT, with $V_{TG} = 350$ mV. (f) Saturated color map of $dV/dI$ at zero bias as a function of $B_\perp$ and $B_z$, showing that the supercurrent is oscillating as a function of both field directions, with $V_{TG} = 0$. (g) Oscillation and re-emergence of switching current, $I_{sw}$ (see main text) vs. $B_z$ for several top-gate voltages, $V_{TG}$.

Speculations about the rise of extra resonances in $\rho_{xx}$ and the addition to $\nu$ that comes with them, lead to an interpretation including a low density and disordered second band. The extra resonances represent its fan diagram. The broad fans indicate low mobility. To explain the observed combined filling factor $\nu$, we suggest that crossing the high field resonance, marked by red arrows in Fig. 6(d), takes the second band filling factor from $\nu_{2nd} = 1$ to 0. Depletion of a Hall bar with $B_z$ is commonly observed in the study of disordered 2DEGs [60]. The origin of such a second band and where it would reside is not clear. It could be related to an unintentional quantum well deeper in the heterostructure.

VII. PATTERNING ANODIC OXIDATION

Combining lithography with anodic oxidation opens a new path toward patterning hybrid heterostructures. In this section, we demonstrated patterning of the AO process, implemented on the InAs 2DEG heterostructure, sample 2. Following a few unsuccessful approaches to patterning, described in SM Sec. I [41], a successful metal-mask approach was implemented, as shown in Fig. 7(a). Following an initial global AO step, a thin Ti metal mask was patterned using electron beam lithography and liftoff, with Ti in the locations where Al should stay metallic. A second AO fully oxidizes the Al not covered by the mask as well as oxidizing the mask itself. Resulting structures are shown in SM Sec. J [41].

The initial oxidation was done at 3.5 V for 5 min. The resulting Al film had $B_{c,||} \approx 5.6$ T and $B_{c,\perp} \approx 300$ mT, similarly to the 3.5 V exposures of Fig. 4, indicating a similar thickness. A final oxidation was done at 4.8 V for 5 min. The Hall bar showed a mobility peak of 1.16 m$^2$/Vs at a density of $7.2 \times 10^{15}$ m$^{-2}$. The mobility is much lower than the one reported for Hall bars in Fig. 5, suggesting the oxidation process was too deep and impacted the semiconductor.

An unintended oxidation depth could be due to a time-dependent AO process, see SM Sec. A [41]. The final oxidation, having the largest $V_{AO}$, was intended to solely control the oxidation thickness. With a time-dependence, the depth of the initial and final oxidation would add up, making our current setup nonideal for this purpose.

This method was used to fabricate 5-$\mu$m-long superconductor-normal-superconductor Josephson junction (JJ) with 100 nm wide superconducting leads and normal
regions varied between 100 and 400 nm, as shown in see Fig. 7(b) and SM Sec. K [41].

Measurement setup and applied field directions are also shown in Fig. 7(b). An out-of-plane field B⊥ is used in combination with an in-plane field B∥, perpendicular to the junction. An ac current bias of 0.5 nA was applied with possibility of adding dc bias, Idc, while an ac voltage drop was measured. A top-gate VTG was used to deplete or populate the junction with carriers. The two wire gates V∥, biased at = −1.6 V, were used to form the narrow junction in the InAs 2DEG enabled by electrostatic screening of the metallic aluminum [23].

Gate control of the supercurrent is shown in Fig. 7(c). Differential resistance (dV/dI) is measured as a function of I∥ and VTG, which related a critical current Ic ∼ 1.1 μA at VTG = 0 V. The Fraunhofer-like pattern of oscillations of critical current as function of perpendicular magnetic field, B⊥, is shown in Fig. 7(d). We observe that the critical current oscillates in B⊥ as seen previously [23,61–63]. For an ideal junction, the critical current is expected to follow:

\[ I_c(B⊥) = I_c(0) \left( \frac{\sin(\pi B⊥ A/\phi_0)}{\pi B⊥ A/\phi_0} \right), \] (1)

\( \phi_0 \) being the flux quantum and A being the junction area which, in our case, is designed to be = 0.1 μm × 5 μm = 50 μm². The observed period of ∼4.5 mT corresponds to an area of 0.46 μm², not far from the designed value.

The perpendicular critical field is estimated to be 310 mT as evidenced in the large field Fraunhofer pattern of Fig. 7(e). This value is consistent with the critical field of full-sheet anodized Al, see SM sec. J [41].

The narrow JJs were made to verify the resolution of the AO lithography with metal masks. A gateable junction verifies that the Al leads are not shorted and the Fraunhofer period indicates that the leads are not broken. This indicates that the horizontal lithographic resolution is better than 50 nm, both away from and in-under the metal mask.

Differential resistance dV/dI was measured at Idc = 0 as a function of B⊥ and B∥ with VTG = 0, displayed on Fig. 7(f). Similar maps were taken at other VTG values, see SM Sec. L [41]. The field directions were aligned to the device axes before data acquisition. A complicated pattern is observed with quenching and reappearance of the supercurrent as a function of both field directions. For B⊥ < 1 T, supercurrent persists for all B∥ ∈ [−20 : 20] mT. Beyond 1 T resistive regimes emerges and broadens out. No supercurrent is present after B⊥ > 4 T, besides two superconducting blobs appearing at high fields B⊥ ∼ 5.5 T, just before the Al goes normal.

Switching current, Iw, defined as the maximum critical current for any B⊥ in a 10 mT interval, as a function of B⊥ between −0.3 T and 5.8 T for VTG between +0.3 V and −1.3 V is shown in Fig. 7(g). For VTG = −1.3 V and −1.1 V, we observe the supercurrent being quenched around B⊥ ∼ 1 T. For VTG = −0.6 V, the junction goes resistive as well around B⊥ ∼ 1 T, but superconductivity reemerges between 1.5 and 2 T. For VTG = 0 and +0.35 V, Iw sustains up to ∼3.4 T, with a local peak around 1.7 T. A finite Iw was also observed for B⊥ between 5.2 and 5.5 T, close to the critical field of the superconductor itself. Resistance of the junction in the normal regime also oscillates with B⊥ but out of phase with the Iw oscillations, as can be seen in SM Sec. L [41]. We observe that the B⊥ values for peaks and dips in Iw are independent of VTG and thus also the InAs chemical potential. The B⊥ value resulting in a topological phase transition is expected to have a chemical potential dependence [21,22]. We therefor attribute the oscillations to be B⊥-induced orbital effects as reported in Ref. [23]. For an orbital effect, periodic nodes and antinodes should be expected. With Iw peaks at B⊥ = 1.7 T and ∼5.4 T, we could be observing 1st and 3rd antinode, while a second antinode around B⊥ ∼ 3.5 T could be suppressed.

VIII. CONCLUSION

In summary, we have developed an anodic oxidation approach to controlling the thickness of epitaxially grown Al on hybrid Al-InAs heterostructures. We apply this process to (i) thin epitaxially grown Al resulting in increased critical temperature and magnetic fields, (ii) passivate hybrid heterostructures with complete oxidation of the Al films so that the interface between the heterostructure and oxide has never been exposed to air, and (iii) pattern superconductor-normal junctions when combined with lithographic processes to produce nanoscale structured superconducting elements, focusing on the case of SNS junctions with sub-100 nm features.

The anodized Al films showed critical fields Bc[∥] > 6 T and Bc⊥ ∼ 3.5 T. Resistivity of thin disordered Al yielded ρxx > 1 kΩ, making the material interesting for high-kinetic impedance superconducting resonators [64]. Full oxidation of the Al increases peak mobility to 8 m²/V s, twice the value obtained with regular Al etch. Quantum Hall effect was observed at ∼2.5 T, giving ∼1 T overlap with highest superconducting critical field, enabling future research into superconductor-quantum Hall hybrids. Applying a metal mask, lithographic resolution <50 nm was achieved.

The different possibilities offered by the anodic oxidation process combined with the improved properties of the resulting films motivate further research in anodic oxidation or other new fabrication processes for hybrid heterostructures. This opens the path towards new applications and new regimes for experiments on hybrid heterostructures.

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